



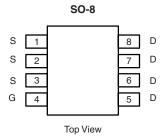
P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
- 20	0.040 at V _{GS} = - 4.5 V	- 6.2		
	0.060 at V _{GS} = - 2.7 V	- 5.0		

FEATURES

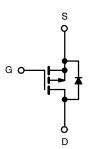
- Halogen-free According to IEC 61249-2-21 Definition
- Compliant to RoHS Directive 2002/95/EC





Ordering Information: Si9433BDY-T1-E3 (Lead (Pb)-free)

Si9433BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 20		V
Gate-Source Voltage		V _{GS}	± 12		
Out! Durin Oursel /T 450 00/3	T _A = 25 °C	- I _D	- 6.2	- 4.5	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 5.0	- 3.5	
Pulsed Drain Current		I _{DM}	- 20		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 2.3	- 1.2	
	T _A = 25 °C	P _D	2.5	1.3	14/
Maximum Power Dissipation ^a	T _A = 70 °C		1.6	0.8	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	45	50	°C/W	
	Steady State		80	95		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	20	24		

Notes:

a. Surface Mounted on FR4 board, $t \le 10 \text{ s.}$

Vishay Siliconix



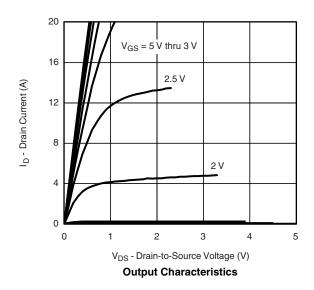
SPECIFICATIONS $T_J = 25$ °C Parameter	Symbol			Typ. ^a	Max.	Unit	
Static	Gynnbor	rest obliditions	Min.	iyp.	IVIQA.	Oilit	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 0.6		- 1.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zone Oata Walle as Busin Oamant	-	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$			- 10		
On-State Drain Current ^b	,	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	V _{GS} = - 4.5 V - 20			^	
	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -2.7 \text{ V}$	- 5			Α	
	D	$V_{GS} = -4.5 \text{ V}, I_D = -6.2 \text{ A}$		0.030	0.040	0	
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = -2.7 \text{ V}, I_D = -5.0 \text{ A}$	7 V, I _D = - 5.0 A 0.050 0		0.060	Ω	
Forward Transconductance ^b	9 _{fs}	$V_{DS} = -9 \text{ V}, I_D = -6.2 \text{ A}$		15		S	
Diode Forward Voltage ^b	V_{SD}	I _S = - 2.6 A, V _{GS} = 0 V		- 0.76	- 1.1	V	
Dynamic ^a							
Total Gate Charge	Q_g			8.8	14		
Gate-Source Charge	Q _{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -6.2 \text{ A}$		1.8		nC	
Gate-Drain Charge	Q_{gd}			2.4			
Gate Resistance	R_g			8.5		Ω	
Turn-On Delay Time	t _{d(on)}			40	60		
Rise Time	t _r	$V_{DD} = -6 V$, $R_L = 6 \Omega$		55	85		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 6 Ω		65	100	ns	
Fall Time	t _f			30	45		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 2.3 A, dl/dt = 100 A/μs		35	55		

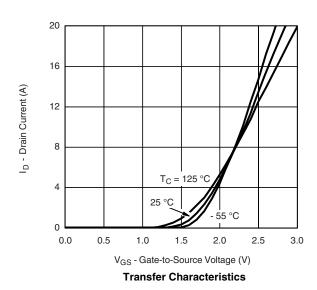
Notes:

- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

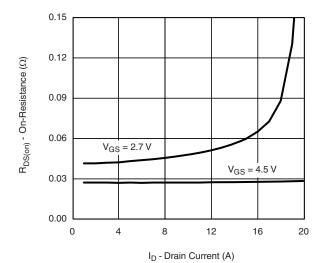




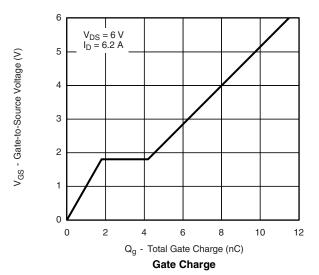


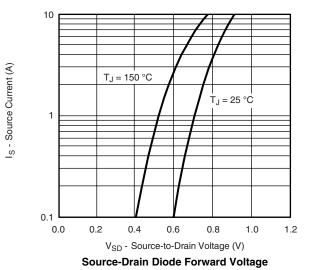


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Drain Current





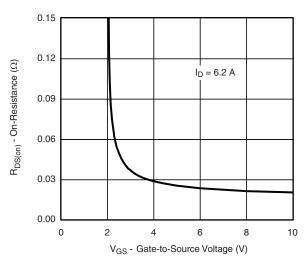
1.6 $V_{GS} = 4.5 V$ $I_D = 6.2 \text{ A}$ 1.4 R_{DS(on)} - On-Resistance (Normalized) 1.2 1.0 8.0 0.6 - 50 - 25 0 25 50 100 125 150

V_{DS} - Drain-to-Source Voltage (V)

Capacitance

T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

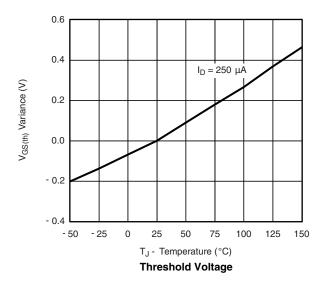


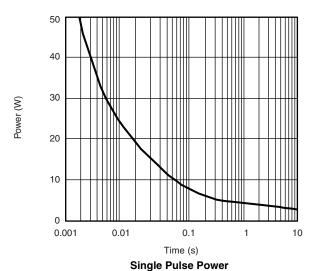
On-Resistance vs. Gate-to-Source Voltage

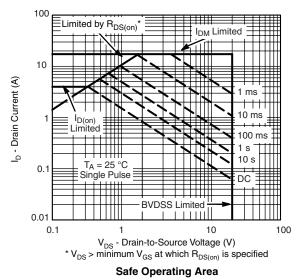
Vishay Siliconix

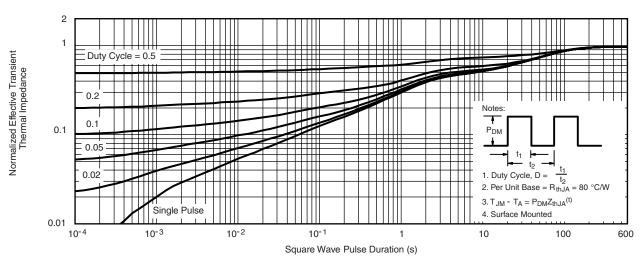
VISHAY.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





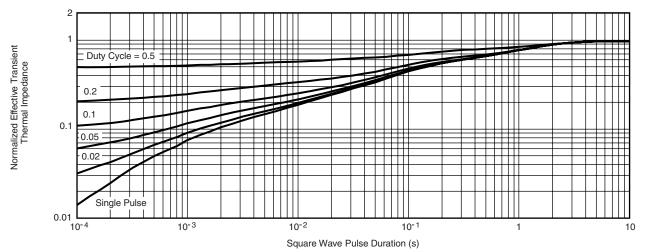




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?72755.



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 Revision: 18-Jul-08